

Data sheet Product ICK SMD G 8 MI



Heatsinks and active heatsinks for processors>Heatsinks for DIL-IC, PLCC and SMD

10 x 6 mm, for SMD components and others

Features

width:	10 mm
height:	6 mm
plate thickness:	1.8 mm
length:	8 mm
thermal resistance:	73 K/W
surface:	solderable surface

Technical Drawing

